

FLEXEM——IIoT HMI FE6000 Series

Module: FE6070C

Overview

Flexem Industrial HMI 6000 Series, a new generation of IIoT human-machine interface. It is high-qu ality and cost-effective touch screen, industrial ABS plastic shell, low cost, high reliability. The main board is treated with a special coating (three anti-paint) to adapt to harsh environments.

The new model is with more practical down-line approach, and the redesigned front face has a better looking look, and higher resolution model is available.

By selecting the FLink IIoT module, you can upgrade to the IIoT human-machine interface immedia tely anduses complete and convenient industrial IIoT cloud platform service.

Appearance









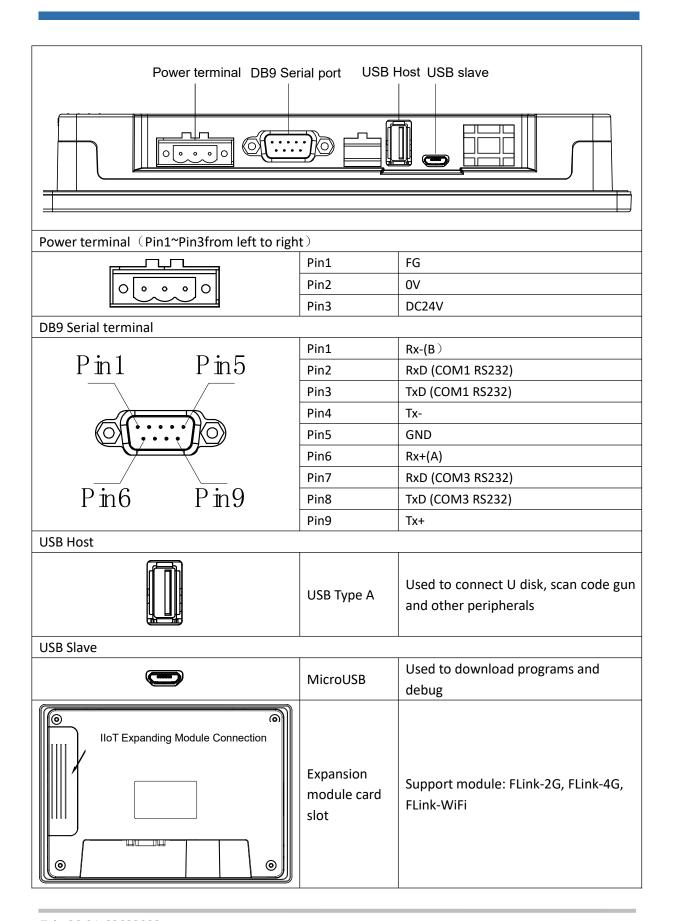


Specifications

| | Display | 7" 16:9 TFT LCD |
|-------------------------------|-----------------------------|---|
| Hardware parameter | Resolution(WxH) | 800×480 |
| | Colors | 24-bit |
| | Brightness | 360 cd/m ² |
| | Backlight | LED |
| | LCD Life | 50000 hours |
| | Touch Panel | 4 wires resistive touch screen |
| | CPU | 600MHz ARM Cortex-A8 |
| | Memory | 128M Flash + 128M DDR3 |
| | RTC | Built in |
| | Ethernet | NA |
| | USB Port | USB Slave 2.0 port*1,USB Host 2.0 port*1 |
| | Download Project | USB Slave/U-disk |
| | COM Port | COM1:RS232/RS485/RS422 |
| | CONTPOR | COM3:RS232 |
| | LCD viewing angle (T/B/L/R) | 50'/70'/70' |
| Electrical Specifications | Power Consumption | <10W |
| | Input Power | DC24V, working range DC 9V~28V |
| | Power Protection | Protected from thunderstrike and surging |
| | Power Down Allowed | <5mS |
| | 07.0.5.110 | Complied with EN61000-6-2:2005, EN61000-6-4:2007, |
| | CE & RoHS | RoHS, Surge Immunity: ±1KV, EFT: ±2KV,ESD:4KV, Air:8KV |
| Environment Specifications | Operating | 0~50℃ |
| | Temperature | |
| | Storage Temperature | -20~60℃ |
| | Anti-UV | Not suitable to work in strong ultraviolet light (such as |
| | | direct sunlight) |
| | Operating Humidity | 10~90%RH(No condensation) |
| | Vibration Endurance | 10~25Hz(X,Y,Z direction 2G/30 minutes) |
| | Cooling method | Natural air cooling |
| Mechanical Index | Degree of Protection | Front IP65(with NEMA panel),Back IP20 |
| | Enclosure | Engineering plastic |
| | Panel Cutout(WxH) | 192mm×138mm |
| | Dimension | 204mm×145mm×33.8mm |
| | Weight | About 560g |

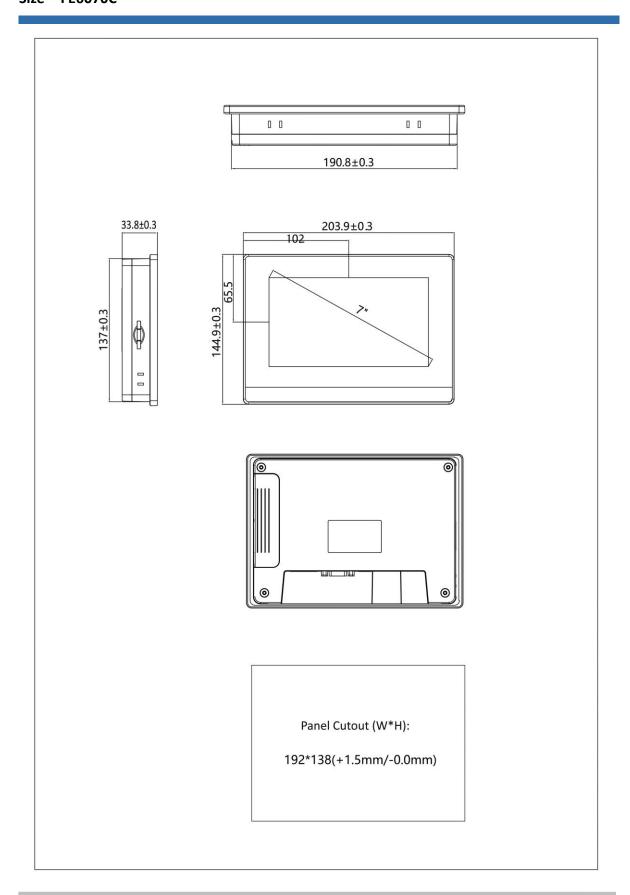
Wiring definition





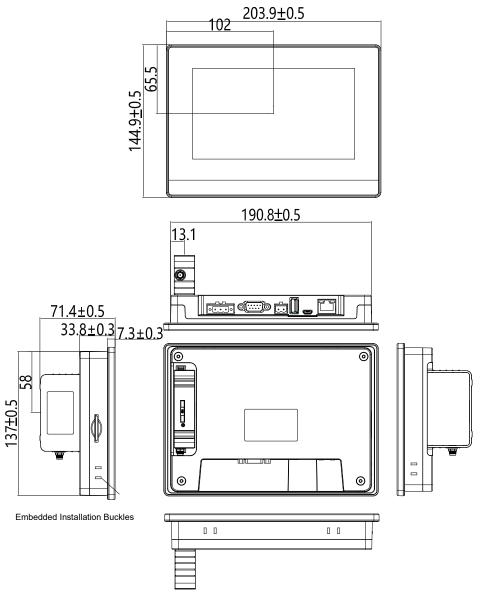


Size FE6070C





Size FE6070C+FLink



Panel Cutout of Embedded installation: 192mm*138mm (+1.0/-0.0mm)



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